



Sample &

Buv







SN74LVCH16245A

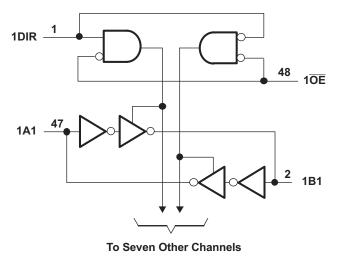
SCES495C -OCTOBER 2003-REVISED JUNE 2014

# SN74LVCH16245A 16-bit Bus Transceiver With 3-state Outputs

#### Features 1

- Member of the Texas Instruments Widebus™ Familv
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max  $t_{pd}$  of 4 ns at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) >2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V  $V_{CC}$ )
- Ioff Supports Live Insertion, Partial-Power-Down Mode, and Back-Drive Protection
- Bus Hold on Data Inputs Eliminates the Need for External Pullup or Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA • Per JESD 17
- ESD Protection Exceeds JESD 22 ٠
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

## Simplified Schematic



#### 2 Applications

- Electronic Points of Sale
- Test and Measurement
- Wearable Health and Fitness Devices
- Tablets

### 3 Description

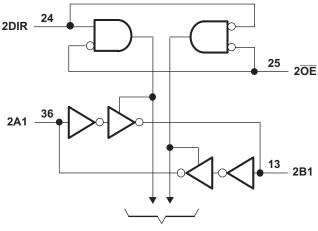
This 16-bit (dual-octal) noninverting bus transceiver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation. The SN74LVCH16245A device is designed for asynchronous communication between data buses.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. Active bus-hold circuitry holds unused or undriven data inputs at a valid logic state.

Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)				
	TSSOP (48)	12.50 mm × 6.10 mm				
SN74LVCH16245A	TVSOP (48)	9.70 mm × 4.40 mm				
	SSOP (48)	15.88 mm × 7.49 mm				

(1) For all available packages, see the orderable addendum at the end of the data sheet.



**To Seven Other Channels** 



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### 5 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### Changes from Revision B (August 2006) to Revision C

•	Updated document to new TI data sheet format	. 1
•	Removed Ordering Information table.	. 1
•	Updated I <sub>off</sub> Feature bullet	. 1
•	Added Applications.	. 1
•	Added Device Information table.	. 1
•	Added Handling Ratings table	6
•	Changed MAX ambient temperature to 125°C.	. 7
•	Added Thermal Information table.	. 7
•	Updated t <sub>sk(o)</sub> values in Switching Characteristics table.	. 9
•	Added Typical Characteristics.	. 9



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# 6 Pin Configuration and Functions

#### **Pin Functions**

PIN		- I/O	DESCRIPTION
NO.	NAME	1/0	DESCRIPTION
1	1DIR	Ι	Direction pin 1
2	1B1	I/O	1B1 input or output
3	1B2	I/O	1B2 input or output
4	GND	—	Ground pin
5	1B3	I/O	1B3 input or output
6	1B4	I/O	1B4 input or output
7	VCC	—	Power pin
8	1B5	I/O	1B5 input or output
9	1B6	I/O	1B6 input or output
10	GND	—	Ground pin
11	1B7	I/O	1B7 input or output
12	1B8	I/O	1B8 input or output
13	2B1	I/O	2B1 input or output
14	2B2	I/O	2B2 input or output
15	GND	—	Ground pin
16	2B3	I/O	2B3 input or output
17	2B4	I/O	2B4 input or output
18	VCC	—	Power pin
19	2B5	I/O	2B5 input or output
20	2B6	I/O	2B6 input or output

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### Pin Functions (continued)

NAME         I/O         DESCRIPTION           21         GND          Ground pin           22         287         I/O         287 input or output           23         288         I/O         288 input or output           24         2DIR          Direction pin 2           25         2OE         1         Output Enable 2           26         2A8         I/O         2A8 input or output           27         2A7         I/O         2A7 input or output           28         GND          Ground pin           29         2A6         I/O         2A8 input or output           30         2A5         I/O         2A4 input or output           31         VCC          Power pin           32         2A3         I/O         2A4 input or output           34         GND          Ground pin           35         2A2         I/O         2A3 input or output           34         GND          Ground pin           35         2A2         I/O         2A2 input or output           36         A7         I/O         1A8 input or output		PIN	I/O	DESCRIPTION
22         287         I/O         287 input or output           23         288         I/O         288 input or output           24         2DIR         —         Direction pin 2           25         20E         I         Output Enable 2           26         2A8         I/O         2A8 input or output           27         2A7         I/O         2A7 input or output           28         GND         —         Ground pin           29         2A6         I/O         2A5 input or output           30         2A5         I/O         2A5 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A1 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A6 input or output           39         GND         —         Ground pin <th>NO.</th> <th>NAME</th> <th>1/0</th> <th>DESCRIPTION</th>	NO.	NAME	1/0	DESCRIPTION
23288I/O288 input or output242DIR—Direction pin 2252DEIOutput Enable 2262A8I/O2A8 input or output272A7I/O2A7 input or output28GND—Ground pin292A6I/O2A6 input or output302A5I/O2A5 input or output31VCC—Power pin322A4I/O2A3 input or output332A3I/O2A3 input or output34GND—Ground pin352A2I/O2A2 input or output362A1I/O2A3 input or output371A8I/O2A1 input or output381A7I/O1A1 input or output411A5I/O1A5 input or output42VCC—Power pin43I/O1A6 input or output44IA6I/O1A5 input or output45GND—Ground pin46I/OIA5 input or output47IA2I/OIA5 input or output	21	GND	—	Ground pin
24         2DIR         —         Direction pin 2           25         2OE         1         Output Enable 2           26         2A8         I/O         2A8 input or output           27         2A7         I/O         2A7 input or output           28         GND         —         Ground pin           29         2A6         I/O         2A6 input or output           30         2A5         I/O         2A5 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A3         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A8 input or output           38         1A7         I/O         1A5 input or output           39         GND         —         Ground pin           41         1A5         I/O         1A5 input or output <td>22</td> <td>2B7</td> <td>I/O</td> <td>2B7 input or output</td>	22	2B7	I/O	2B7 input or output
25         20E         I         Output Enable 2           26         2A8         I/O         2A8 input or output           27         2A7         I/O         2A7 input or output           28         GND         —         Ground pin           29         2A6         I/O         2A6 input or output           30         2A5         I/O         2A6 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A3 input or output           33         2A3         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A8 input or output           38         IA7         I/O         1A7 input or output           39         GND         —         Ground pin           40         IA6         I/O         IA5 input or outp	23	2B8	I/O	2B8 input or output
26         2A8         I/O         2A8 input or output           27         2A7         I/O         2A7 input or output           28         GND         —         Ground pin           29         2A6         I/O         2A6 input or output           30         2A5         I/O         2A5 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A4 input or output           33         2A3         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A8 input or output           38         1A7         I/O         1A7 input or output           39         GND         —         Ground pin           40         1A6         I/O         1A6 input or output           41         1A5         I/O         1A5 input or output           42         VCC         —         Power pin           43         IA4         I/O         IA4 input or	24	2DIR	—	Direction pin 2
27         2A7         I/O         2A7 input or output           28         GND         —         Ground pin           29         2A6         I/O         2A6 input or output           30         2A5         I/O         2A5 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A3 input or output           33         2A3         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         2A1 input or output           38         1A7         I/O         1A7 input or output           39         GND         —         Ground pin           40         1A6         I/O         1A6 input or output           41         1A5         I/O         1A5 input or output           42         VCC         —         Power pin           43         1A4         I/O         1A4 input or output           44         IA3         I/O         IA3 input or	25	2 <del>0E</del>	I	Output Enable 2
28         GND         —         Ground pin           29         2A6         I/O         2A6 input or output           30         2A5         I/O         2A5 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A4 input or output           33         2A3         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A8 input or output           38         1A7         I/O         1A7 input or output           39         GND         —         Ground pin           41         1A5         I/O         1A5 input or output           42         VCC         —         Power pin           43         IA4         I/O         1A5 input or output           44         1A3         I/O         1A3 input or output           45         GND         —         Ground pin           44         IA3         I/O         1A4 input or output <td>26</td> <td>2A8</td> <td>I/O</td> <td>2A8 input or output</td>	26	2A8	I/O	2A8 input or output
29         2A6         I/O         2A6 input or output           30         2A5         I/O         2A5 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A4 input or output           33         2A3         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A8 input or output           38         1A7         I/O         1A7 input or output           39         GND         —         Ground pin           41         1A5         I/O         1A6 input or output           42         VCC         —         Power pin           43         1A4         I/O         1A4 input or output           44         1A3         I/O         1A4 input or output           45         GND         —         Ground pin           46         I/A2         I/O         1A4 input or output	27	2A7	I/O	2A7 input or output
30         2A5         I/O         2A5 input or output           31         VCC         —         Power pin           32         2A4         I/O         2A4 input or output           33         2A3         I/O         2A3 input or output           34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A8 input or output           38         1A7         I/O         1A7 input or output           39         GND         —         Ground pin           40         1A6         I/O         1A6 input or output           41         1A5         I/O         1A5 input or output           42         VCC         —         Power pin           43         1A4         I/O         1A4 input or output           44         1A3         I/O         1A3 input or output           45         GND         —         Ground pin           46         1A2         I/O         1A2 input or output	28	GND	—	Ground pin
31       VCC       —       Power pin         32       2A4       I/O       2A4 input or output         33       2A3       I/O       2A3 input or output         34       GND       —       Ground pin         35       2A2       I/O       2A2 input or output         36       2A1       I/O       2A2 input or output         37       1A8       I/O       1A8 input or output         38       1A7       I/O       1A7 input or output         39       GND       —       Ground pin         40       1A6       I/O       1A6 input or output         41       1A5       I/O       1A5 input or output         42       VCC       —       Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND       —       Ground pin         46       1A2       I/O       1A2 input or output	29	2A6	I/O	2A6 input or output
32       2A4       I/O       2A4 input or output         33       2A3       I/O       2A3 input or output         34       GND       —       Ground pin         35       2A2       I/O       2A2 input or output         36       2A1       I/O       2A1 input or output         37       1A8       I/O       1A8 input or output         38       1A7       I/O       1A7 input or output         39       GND       —       Ground pin         40       1A6       I/O       1A6 input or output         41       1A5       I/O       1A6 input or output         42       VCC       —       Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND       —       Ground pin         46       1A2       I/O       1A2 input or output	30	2A5	I/O	2A5 input or output
33       2A3       I/O       2A3 input or output         34       GND       —       Ground pin         35       2A2       I/O       2A2 input or output         36       2A1       I/O       2A1 input or output         37       1A8       I/O       1A8 input or output         38       1A7       I/O       1A7 input or output         39       GND       —       Ground pin         40       1A6       I/O       1A6 input or output         41       1A5       I/O       1A5 input or output         42       VCC       —       Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND       —       Ground pin         46       1A2       I/O       1A2 input or output	31	VCC	_	Power pin
34         GND         —         Ground pin           35         2A2         I/O         2A2 input or output           36         2A1         I/O         2A1 input or output           37         1A8         I/O         1A8 input or output           38         1A7         I/O         1A7 input or output           39         GND         —         Ground pin           40         1A6         I/O         1A6 input or output           41         1A5         I/O         1A5 input or output           42         VCC         —         Power pin           43         1A4         I/O         1A4 input or output           45         GND         —         Ground pin           47         1A1         I/O         1A4 input or output	32	2A4	I/O	2A4 input or output
35       2A2       I/O       2A2 input or output         36       2A1       I/O       2A1 input or output         37       1A8       I/O       1A8 input or output         38       1A7       I/O       1A7 input or output         39       GND       —       Ground pin         40       1A6       I/O       1A6 input or output         41       1A5       I/O       1A5 input or output         42       VCC       —       Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND       —       Ground pin         46       1A2       I/O       1A2 input or output	33	2A3	I/O	2A3 input or output
36       2A1       I/O       2A1 input or output         37       1A8       I/O       1A8 input or output         38       1A7       I/O       1A7 input or output         39       GND       —       Ground pin         40       1A6       I/O       1A6 input or output         41       1A5       I/O       1A5 input or output         42       VCC       —       Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND       —       Ground pin         46       1A2       I/O       1A2 input or output         47       1A1       I/O       1A1 input or output	34	GND	—	Ground pin
37       1A8       I/O       1A8 input or output         38       1A7       I/O       1A7 input or output         39       GND       —       Ground pin         40       1A6       I/O       1A6 input or output         41       1A5       I/O       1A5 input or output         42       VCC       —       Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND       —       Ground pin         46       1A2       I/O       1A2 input or output         47       1A1       I/O       1A1 input or output	35	2A2	I/O	2A2 input or output
38       1A7       I/O       1A7 input or output         39       GND       —       Ground pin         40       1A6       I/O       1A6 input or output         41       1A5       I/O       1A5 input or output         42       VCC       —       Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND       —       Ground pin         46       1A2       I/O       1A2 input or output         47       1A1       I/O       1A1 input or output	36	2A1	I/O	2A1 input or output
39GND—Ground pin401A6I/O1A6 input or output411A5I/O1A5 input or output42VCC—Power pin431A4I/O1A4 input or output441A3I/O1A3 input or output45GND—Ground pin461A2I/O1A2 input or output471A1I/O1A1 input or output	37	1A8	I/O	1A8 input or output
401A6I/O1A6 input or output411A5I/O1A5 input or output42VCC—Power pin431A4I/O1A4 input or output441A3I/O1A3 input or output45GND—Ground pin461A2I/O1A2 input or output471A1I/O1A1 input or output	38	1A7	I/O	1A7 input or output
41       1A5       I/O       1A5 input or output         42       VCC        Power pin         43       1A4       I/O       1A4 input or output         44       1A3       I/O       1A3 input or output         45       GND        Ground pin         46       1A2       I/O       1A2 input or output         47       1A1       I/O       1A1 input or output	39	GND	—	Ground pin
42         VCC         —         Power pin           43         1A4         I/O         1A4 input or output           44         1A3         I/O         1A3 input or output           45         GND         —         Ground pin           46         1A2         I/O         1A2 input or output           47         1A1         I/O         1A1 input or output	40	1A6	I/O	1A6 input or output
431A4I/O1A4 input or output441A3I/O1A3 input or output45GND—Ground pin461A2I/O1A2 input or output471A1I/O1A1 input or output	41	1A5	I/O	1A5 input or output
44         1A3         I/O         1A3 input or output           45         GND         —         Ground pin           46         1A2         I/O         1A2 input or output           47         1A1         I/O         1A1 input or output	42	VCC	—	Power pin
45         GND         —         Ground pin           46         1A2         I/O         1A2 input or output           47         1A1         I/O         1A1 input or output	43	1A4	I/O	1A4 input or output
46         1A2         I/O         1A2 input or output           47         1A1         I/O         1A1 input or output	44	1A3	I/O	1A3 input or output
47 1A1 I/O 1A1 input or output	45	GND		Ground pin
	46	1A2	I/O	1A2 input or output
48 10E I Output Enable 1	47	1A1	I/O	1A1 input or output
	48	1 <del>0E</del>	<u> </u>	Output Enable 1

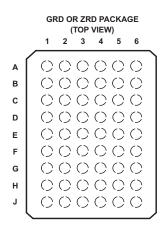


G	GQL OR ZQL PACKAGE (TOP VIEW)						
	_1	2	3	4	5	6	_
A B C D E F G H J K	0000000000		000 000	000 000	000000000	000000000	

## Table 1. Pin Assignments<sup>(1)</sup> (56-Ball GQL or ZQL Package)

	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	1 OE
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	V <sub>CC</sub>	V <sub>CC</sub>	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
E	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
н	2B5	2B6	V <sub>CC</sub>	V <sub>CC</sub>	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
К	2DIR	NC	NC	NC	NC	2 <del>0E</del>

(1) NC - No internal connection



#### Table 2. Pin Assignments<sup>(1)</sup> (54-Ball GRD or ZRD Package)

	1	2	3	4	5	6
Α	1B1	NC	1DIR	1 <del>0E</del>	NC	1A1
В	1B3	1B2	NC	NC	1A2	1A3
С	1B5	1B4	V <sub>CC</sub>	V <sub>CC</sub>	1A4	1A5
D	1B7	1B6	GND	GND	1A6	1A7
E	2B1	1B8	GND	GND	1A8	2A1
F	2B3	2B2	GND	GND	2A2	2A3
G	2B5	2B4	V <sub>CC</sub>	V <sub>CC</sub>	2A4	2A5
н	2B7	2B6	NC	NC	2A6	2A7
J	2B8	NC	2DIR	2 <del>0E</del>	NC	2A8

(1) NC - No internal connection

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### 7 Specifications

# 7.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range		-0.5	6.5	V
VI	Input voltage range <sup>(2)</sup>		-0.5	6.5	V
Vo	Voltage range applied to any output in the hi	Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup>		6.5	V
Vo	Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>		-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
I <sub>O</sub>	Continuous output current			±50	mA
	Continuous current through each $V_{CC}$ or GN	D		±100	mA

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of  $V_{CC}$  is provided in the recommended operating conditions table.

#### 7.2 Handling Ratings

			MIN	MAX	UNIT
T <sub>stg</sub>	Storage temperature rang	ge	-65	150	°C
V	Electrostatia discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	0	2000	
V <sub>(ESD)</sub>	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	0	1000	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



#### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

			MIN	MAX	UNIT	
V	Supply voltage	Operating	1.65	3.6	V	
V <sub>CC</sub>	Supply voltage	Data retention only	1.5		v	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
VIH	High-level input voltage	$V_{CC}$ = 2.3 V to 2.7 V	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		1	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.	35 × V <sub>CC</sub>		
VIL	Low-level input voltage	$V_{CC}$ = 2.3 V to 2.7 V		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
VI	Input voltage	· · · ·	0	5.5	V	
	Output voltage	High or low state	0	V <sub>CC</sub>	V	
Vo		3-state	0	5.5	V	
		V <sub>CC</sub> = 1.65 V		-4		
	Park Incode a devide source of	V <sub>CC</sub> = 2.3 V		-8		
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 2.7 V		-12	mA	
		$V_{CC} = 3 V$		-24		
		V <sub>CC</sub> = 1.65 V		4		
		V <sub>CC</sub> = 2.3 V		8		
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 2.7 V		12	mA	
		$V_{CC} = 3 V$		24		
Δt/Δv	Input transition rise and fall rate	· · ·		5	ns/V	
T <sub>A</sub>	Operating free-air temperature		-40	125	°C	

(1) All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

#### 7.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>	DGG	DGV	DL	LINUT
		48 PINS	48 PINS	48 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	67.1	80.2	70.6	
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	19.9	32.7	36.8	
$R_{\theta JB}$	Junction-to-board thermal resistance	34.2	43.5	43.1	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	1.8	4.7	13.9	°C/W
$\psi_{JB}$	Junction-to-board characterization parameter	33.9	42.9	42.6	
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	n/a	n/a	n/a	

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, SPRA953.

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ISTRUMENTS

EXAS

#### 7.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

P/	ARAMETER	TEST CONDI	TIONS	V <sub>cc</sub>	MIN	TYP <sup>(1)</sup> MA	X UNIT
		I <sub>OH</sub> = −100 μA		1.65 V to 3.6 V	$V_{CC} - 0.2$		
		$I_{OH} = -4 \text{ mA}$		1.65 V	1.2		
V		$I_{OH} = -8 \text{ mA}$		2.3 V	1.7		V
V <sub>OH</sub>		1 10 m A		2.7 V	2.2		v
		I <sub>OH</sub> = -12 mA		3 V	2.4		
		I <sub>OH</sub> = -24 mA		3 V	2.2		
V <sub>OL</sub>		I <sub>OL</sub> = 100 μA		1.65 V to 3.6 V		C	.2
		I <sub>OL</sub> = 4 mA		1.65 V		0.4	45
		I <sub>OL</sub> = 8 mA		2.3 V		C	.7 V
		I <sub>OL</sub> = 12 mA		2.7 V		C	.4
		I <sub>OL</sub> = 24 mA		3 V		0.	55
I <sub>I</sub>	Control inputs	V <sub>I</sub> = 0 to 5.5 V		3.6 V		:	<b>⊧</b> 5 μΑ
		V <sub>I</sub> = 0.58 V			15		
		V <sub>I</sub> = 1.07 V		1.65 V	-15		
		V <sub>I</sub> = 0.7 V		221	45		
I <sub>I(hold)</sub>	A or B port	V <sub>I</sub> = 1.7 V		2.3 V	-45		μA
		V <sub>I</sub> = 0.8 V		2.14	75		
		V <sub>1</sub> = 2 V		3 V	-75		
		$V_{\rm I} = 0$ to 3.6 V <sup>(2)</sup>		3.6 V		±5	00
I <sub>off</sub>		$V_{\rm I}$ or $V_{\rm O}$ = 5.5 V		0		±	10 μA
$I_{OZ}^{(3)}$		$V_{O} = 0 V \text{ or } (V_{CC} \text{ to } 5.5 V)$		2.3 V to 3.6 V		:	<b>⊧</b> 5 μΑ
		$V_{I} = V_{CC}$ or GND		2.0.1		:	20
I <sub>CC</sub>		$3.6 \text{ V} \le \text{V}_1 \le 5.5 \text{ V}^{(4)}$	l <sub>O</sub> = 0	3.6 V		:	μA 20
ΔI <sub>CC</sub>		One input at V <sub>CC</sub> - 0.6 V, Othe	er inputs at V <sub>CC</sub> or GND	2.7 V to 3.6 V		5	00 μA
Ci	Control inputs	$V_{I} = V_{CC}$ or GND		3.3 V	5		
Cio	A or B port	$V_0 = V_{CC}$ or GND		3.3 V		7.5	pF

 All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.
 This is the bus-hold maximum dynamic current required to switch the input from one state to another.
 For the total leakage current in an I/O port, consult the I<sub>I(hold)</sub> specification for the input voltage condition 0 V < V<sub>I</sub> < V<sub>CC</sub>, and the I<sub>OZ</sub> specification for the input voltage conditions V<sub>I</sub> = 0 V or V<sub>I</sub> = V<sub>CC</sub> to 5.5 V. The bus-hold current, at input voltage greater than V<sub>CC</sub>, is specificable. negligible.

This applies in the disabled state only. (4)



#### 7.6 Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

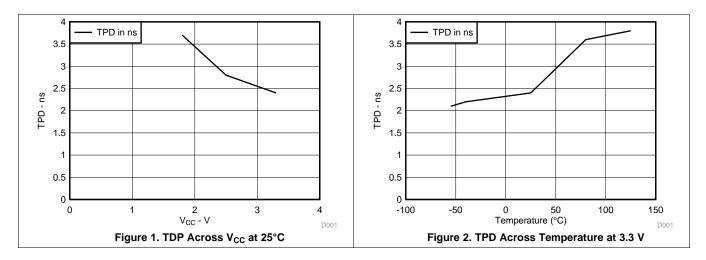
PARAMETER	FROM	TO	V <sub>CC</sub> = 1.8 V ± 0.15 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	1.5	7.1	1	4.5	1	4.7	1	4	ns
t <sub>en</sub>	OE	A or B	1.5	8.9	1	5.6	1.5	6.7	1.5	5.5	ns
t <sub>dis</sub>	OE	A or B	1.5	11.9	1	6.8	1.5	7.1	1.5	6.6	ns
t <sub>sk(o)</sub>				1		1		1		1	ns

#### 7.7 Operating Characteristics

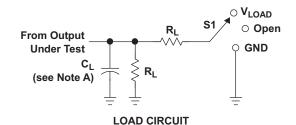
 $T_A = 25^{\circ}C$ 

	PARAMETER		TEST CONDITIONS	V <sub>CC</sub> = 1.8 V TYP	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	UNIT
<u> </u>	Power dissipation capacitance	Outputs enabled	£ 10 MU	36	36	40	۶F
Cpd	per transceiver	Outputs disabled	f = 10 MHz	3	3	4	рг

### 7.8 Typical Characteristics

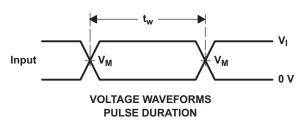


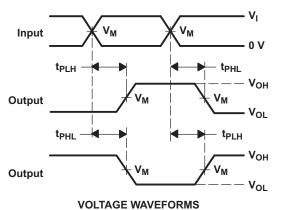
### 8 Parameter Measurement Information

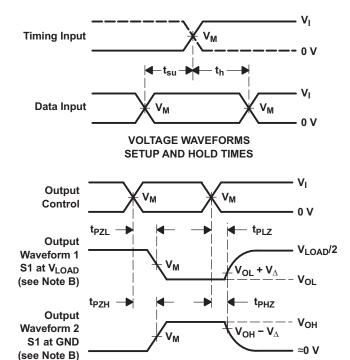


TEST	S1
t <sub>PLH</sub> /t <sub>PHL</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

N	INF	PUTS		N	•	-	N
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	V <sub>LOAD</sub>	CL	RL	$V_{\Delta}$
1.8 V ± 0.15 V	V <sub>cc</sub>	≤2 ns	V <sub>CC</sub> /2	2 × V <sub>CC</sub>	30 pF	<b>1 k</b> Ω	0.15 V
$2.5~V\pm0.2~V$	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	2 × V <sub>CC</sub>	30 pF	<b>500</b> Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	<b>500</b> Ω	0.3 V
$3.3 V \pm 0.3 V$	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	<b>500</b> Ω	0.3 V







#### VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
   C. All input pulses are supplied by generators having the following characteristics: PRR≤ 10 MHz, Z<sub>O</sub> = 50 Ω.
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .

**PROPAGATION DELAY TIMES** 

INVERTING AND NONINVERTING OUTPUTS

- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 3. Load Circuit and Voltage Waveforms

10 Submit Documentation Feedback



#### 9 Detailed Description

#### 9.1 Overview

The SN74LVCH16245A device is designed for asynchronous communication between data buses. The logic levels of the direction-control (DIR) input and the output-enable ( $\overline{OE}$ ) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic high or low level applied to prevent excess I<sub>CC</sub> and I<sub>CCZ</sub>.

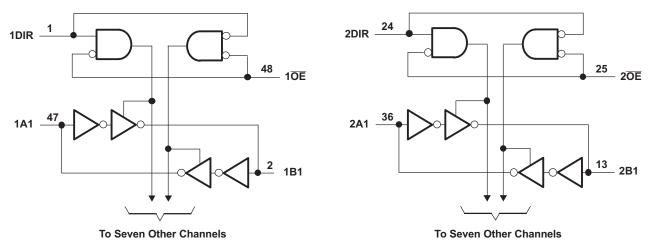
Active bus-hold circuitry holds unused or undriven data inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended. The bus-hold circuitry is part of the input circuit and is not disabled by  $\overline{\text{OE}}$  or DIR.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V and 5-V system environment.

This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, thus preventing damaging current backflow through the device when it is powered down.

#### 9.2 Functional Block Diagram





#### SN74LVCH16245A

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#### 9.3 Feature Description

- Wide operating voltage range
  - Operates from 1.65 V to 3.6 V
- Allows down voltage translation
  - Inputs accept voltages to 5.5 V
- I<sub>off</sub> feature
  - Allows voltages on the inputs and outputs when  $V_{\text{CC}}$  is 0 V

#### 9.4 Device Functional Modes

(Each 8-bit Section)									
CONTROL INPUTS OPERATION									
OE	DIR	OPERATION							
L	L	B data to A bus							
L	Н	A data to B bus							
Н	Х	Isolation							

Table 3. Function Table<sup>(1)</sup>

(1) Input circuits of the data I/Os always are active.



### **10** Application and Implementation

#### **10.1** Application Information

The SN74LVC16245A device is a 16-bit bidirectional transceiver. This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ( $\overline{OE}$ ) input can be used to disable the device so that the buses are effectively isolated. The device has 5.5 V tolerant inputs at any valid V<sub>CC</sub>. This allows it to be used in multi-power systems, and it can be used for down translation.

#### **10.2 Typical Application**

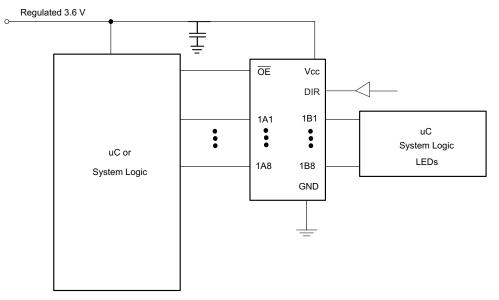


Figure 5. Typical Application Diagram

#### **10.2.1** Design Requirements

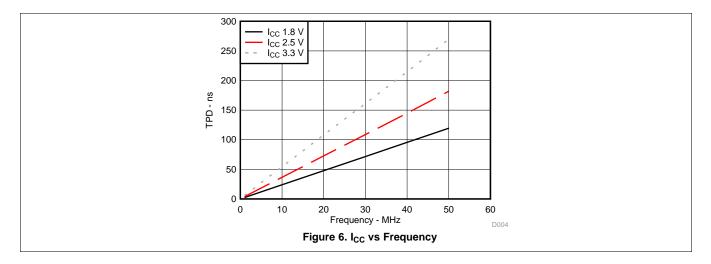
This device uses CMOS technology and has balanced output drive. Care should be taken to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads; therefore, routing and load conditions should be considered to prevent ringing.

#### 10.2.2 Detailed Design Procedure

- 1. Recommended Input Conditions
  - Rise time and fall time specs: See ( $\Delta t/\Delta V$ ) in the *Recommended Operating Conditions* table.
  - Specified high and low levels: See (V<sub>IH</sub> and V<sub>IL</sub>) in the *Recommended Operating Conditions* table.
  - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid  $V_{CC}$ .
- 2. Recommend Output Conditions
  - Load currents should not exceed 25 mA per output and 50 mA total for the part.
  - Outputs should not be pulled above V<sub>CC</sub>.



### Typical Application (continued) 10.2.3 Application Curves



### 11 Power Supply Recommendations

The power supply can be any voltage between the MIN and MAX supply voltage rating located in the *Recommended Operating Conditions* table.

Each  $V_{CC}$  pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, 0.1 µf is recommended; if there are multiple  $V_{CC}$  pins, then 0.01 µf or 0.022 µf is recommended for each power pin. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. A 0.1 µf and a 1 µf are commonly used in parallel. The bypass capacitor should be installed as close to the power pin as possible for best results.

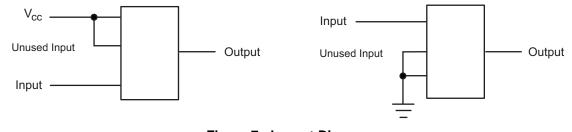
### 12 Layout

#### 12.1 Layout Guidelines

When using multiple-bit logic devices, inputs should never float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Figure 7 specifies the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$ , whichever makes more sense or is more convenient. It is generally acceptable to float outputs, unless the part is a transceiver. If the transceiver has an output enable pin, it will disable the output section of the part when asserted. This will not disable the input section of the l/Os, so they cannot float when disabled.

#### 12.2 Layout Example





### **13 Device and Documentation Support**

#### 13.1 Trademarks

Widebus is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

#### **13.2 Electrostatic Discharge Caution**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 13.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
	10TU/5			40			(6)				
74LVCH16245ADGGRG4	ACTIVE	TSSOP	DGG	48	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVCH16245A	Samples
74LVCH16245ADLRG4	ACTIVE	SSOP	DL	48	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVCH16245A	Samples
SN74LVCH16245ADGGR	ACTIVE	TSSOP	DGG	48	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVCH16245A	Samples
SN74LVCH16245ADGVR	ACTIVE	TVSOP	DGV	48	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LDH245A	Samples
SN74LVCH16245ADL	ACTIVE	SSOP	DL	48	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVCH16245A	Samples
SN74LVCH16245ADLR	ACTIVE	SSOP	DL	48	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LVCH16245A	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



# PACKAGE OPTION ADDENDUM

20-Jan-2021

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# PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	All dimensions are nominal											
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVCH16245ADGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	13.0	1.8	12.0	24.0	Q1
SN74LVCH16245ADGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74LVCH16245ADLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

13-Jan-2021



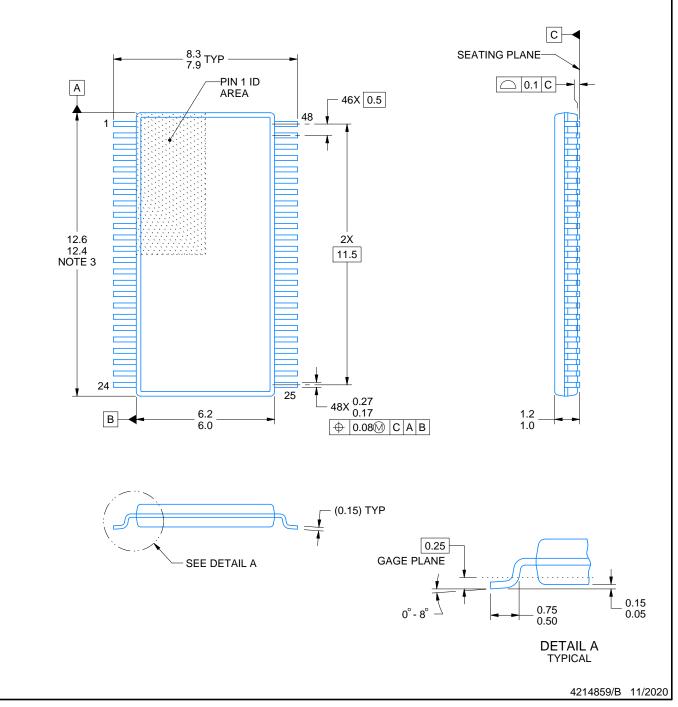
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVCH16245ADGGR	TSSOP	DGG	48	2000	367.0	367.0	45.0
SN74LVCH16245ADGVR	TVSOP	DGV	48	2000	853.0	449.0	35.0
SN74LVCH16245ADLR	SSOP	DL	48	1000	367.0	367.0	55.0

# **PACKAGE OUTLINE**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  This drawing is subject to change without notice.
  This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not

- exceed 0.15 mm per side. 4. Reference JEDEC registration MO-153.



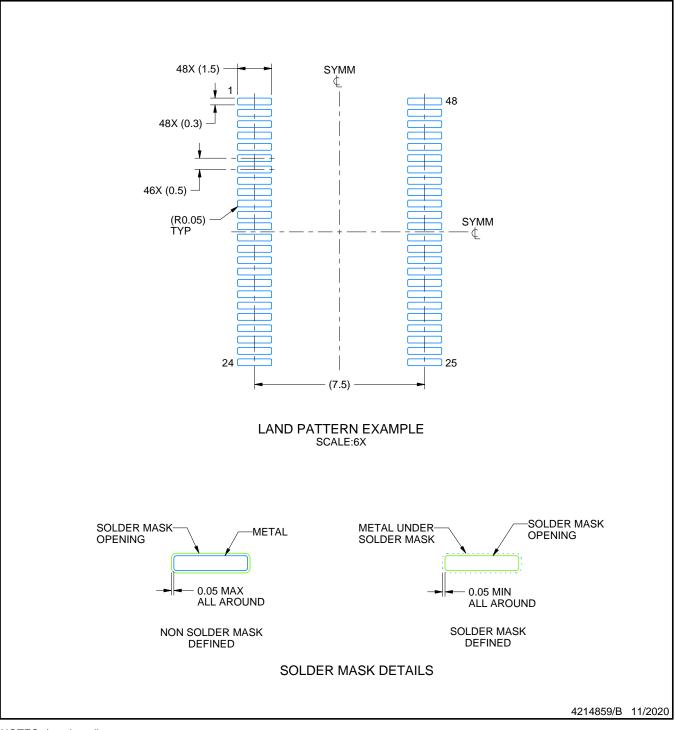
# **DGG0048A**

# DGG0048A

# **EXAMPLE BOARD LAYOUT**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DGG0048A

# **EXAMPLE STENCIL DESIGN**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate

design recommendations. 8. Board assembly site may have different recommendations for stencil design.



## **MECHANICAL DATA**

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

#### DGG (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

**48 PINS SHOWN** 



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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